



RECOMMEND P.C.B. LAYOUT  
TOP VIEW

**NOTES**

**\*Material:**

- 1.Body: PPS UL 94V-0 Rated, Color:Black;
- 2.Cover: PPS UL 94V-0 Rated, Color:Black;
- 3.Contact: Phosphor Bronze;
- 4.Contact Plating: Gold Plating Over Nickel on Contact Area, Tin Plating on Solder Tail.

**\*Specification:**

- 1.Current Rating: 0.5 AMP. Max.;
- 2.Dielectric Withstanding Voltage: 500V AC R.M.S For One Minute;
- 3.Insulation Resistance: 1000 M Ohms Min. AT 500V AC;
- 4.Contact Resistance: 30 M Ohms Max.;
- 5.Operating Temperature: -25°C to +85°C;
- 6.Processing Temp: 230°C for 30~60 Seconds Max.;
- 7.Durability: 5000 Cycles.

<b>RoHS Compliant</b>		<b>HSM 玄茂科技股份有限公司</b>	
		<b>HSUAN MAO TECHNOLOGY CO., LTD.</b>	
APPD. 核准 <b>Megan</b>		TOLERANCES ARE .X ± 0.38 .XX ± 0.25 .XXX ± 0.20 AWG	PART NAME 品名 SIM CARD BLOCK TYPE HINGED COVER 6P H:2.3mm GOLD 3U" BLACK INSULATOR WITH POST ROHS LOW-LEAD
DWG. 製圖 <b>Hedy</b>		SCALE 比例 參考	SIZE. 紙張尺寸 A 4
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